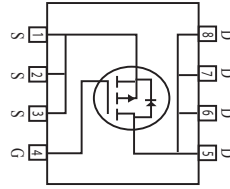


## Surface Mount P-Channel Enhancement Mode MOSFET

**(Pb)** Lead(Pb)-Free



**DRAIN CURRENT**  
**-4.8 AMPERS**  
**DRAIN SOURCE VOLTAGE**  
**-30 VOLTAGE**

### Features:

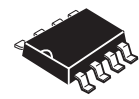
\*Super high dense cell design for low  $R_{DS(ON)}$

$R_{DS(ON)} < 55 \text{ m}\Omega @ V_{GS} = -10\text{V}$

$R_{DS(ON)} < 85 \text{ m}\Omega @ V_{GS} = -4.5\text{V}$

\*Rugged and Reliable

\*SO-8 Package



**SO-8**

## Maximum Ratings (TA=25°C Unless Otherwise Specified)

Rating	Symbol	Value	Unite
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current ( $T_J = 125^\circ\text{C}$ ) <sup>(1)</sup>	$I_D$	-4.8	A
Pulsed Drain Current <sup>(2)</sup>	$I_{DM}$	-24	A
Drain-Source Diode Forward Current (1)	$I_S$	-1.7	A
Power Dissipation (1)	$P_D$	2.5	W
Maximax Junction-to-Ambient	$R_{\theta JA}$	50	$^\circ\text{C/W}$
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to 150	$^\circ\text{C}$

## Device Marking

WT9435M=STM9435

**Electrical Characteristics** ( $T_A=25^\circ\text{C}$  Unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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**Static (2)**

Drain-Source Breakdown Voltage $V_{GS}=0V, I_D=-250\ \mu\text{A}$	$V_{(BR)DSS}$	-30	-	-	V
Gate-Source Threshold Voltage $V_{DS}=V_{GS}, I_D=-250\ \mu\text{A}$	$V_{GS(th)}$	-1	-1.5	-2.5	V
Gate-Source Leakage Current $V_{DS}=0V, V_{GS}=\pm 20V$	$I_{GSS}$	-	-	$\pm 100$	nA
Zero Gate Voltage Drain Current $V_{DS}=-24V, V_{GS}=0V$	$I_{DSS}$	-	-	-1	$\mu\text{A}$
Drain-Source On-Resistance $V_{GS}=-10V, I_D=-5.3A$ $V_{GS}=-4.5V, I_D=-4.2A$	$r_{DS(on)}$	- -	45 75	55 85	$\text{m}\Omega$
On-State Drain Current $V_{DS}=-5V, V_{GS}=-10A$	$I_{D(on)}$	-20	-	-	A
Forward Transconductance $V_{DS}=-5V, I_D=-5.3A$	$g_{fs}$	-	5	-	S

**Dynamic (3)**

Input Capacitance $V_{DS}=-15V, V_{GS}=0V, f=1\text{MHz}$	$C_{iss}$	-	582	-	PF
Output Capacitance $V_{DS}=-15V, V_{GS}=0V, f=1\text{MHz}$	$C_{oss}$	-	125	-	
Reverse Transfer Capacitance $V_{DS}=-15V, V_{GS}=0V, f=1\text{MHz}$	$C_{rss}$	-	86	-	

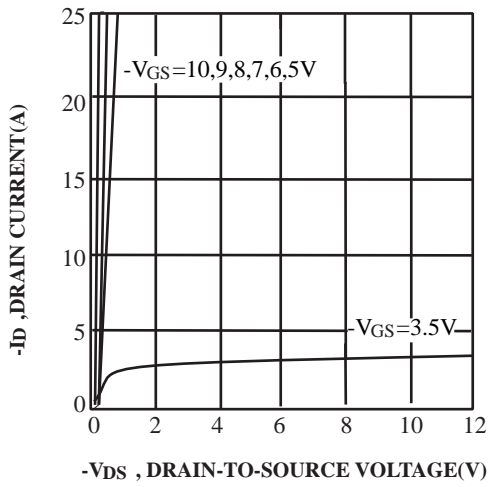
**Switching (3)**

Turn-On Delay Time $V_{GEN}=-10V, V_{DD}=-15V, I_D=-1A, R_L=15\ \Omega, R_{GEN}=6\ \Omega$	$t_{d(on)}$	-	9	-	nS
Rise Time $V_{GEN}=-10V, V_{DD}=-15V, I_D=-1A, R_L=15\ \Omega, R_{GEN}=6\ \Omega$	$t_r$	-	10	-	nS
Turn-Off Time $V_{GEN}=-10V, V_{DD}=-15V, I_D=-1A, R_L=15\ \Omega, R_{GEN}=6\ \Omega$	$t_{d(off)}$	-	37	-	nS
Fall Time $V_{GEN}=-10V, V_{DD}=-15V, I_D=-1A, R_L=15\ \Omega, R_{GEN}=6\ \Omega$	$t_f$	-	23	-	nS
Total Gate Charge $V_{DS}=-15V, I_D=-5.3A, V_{GS}=-10V$ $V_{DS}=-15V, I_D=-5.3A, V_{GS}=-4.5V$	$Q_g$	- -	11.7 5.7	- -	nc
Gate-Source Charge $V_{DS}=-15V, I_D=-5.3A, V_{GS}=-10V$	$Q_{gs}$	-	2.1	-	nc
Gate-Drain Charge $V_{DS}=-15V, I_D=-5.3A, V_{GS}=-10V$	$Q_{gd}$	-	2.9	-	nc
Drain-Source Diode Forward Voltage $V_{GS}=0V, I_S=-1.7A$	$V_{SD}$	-	-0.84	-1.2	V

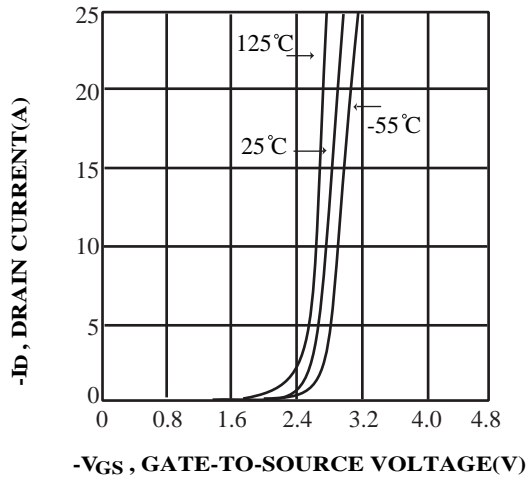
Note: 1. Surface Mounted on FR4 Board  $t \leq 10\text{sec}$ .

2. Pulse Test :  $PW \leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

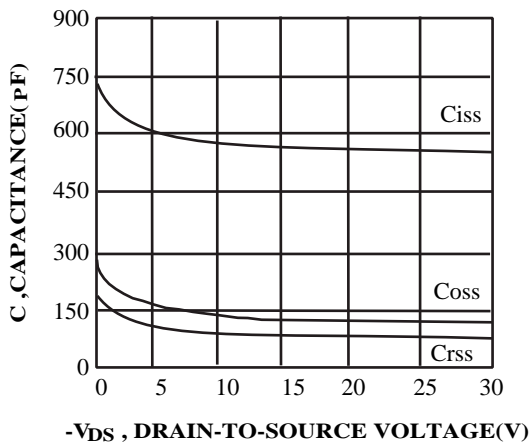
3. Guaranteed by Design, not Subject to Production Testing.



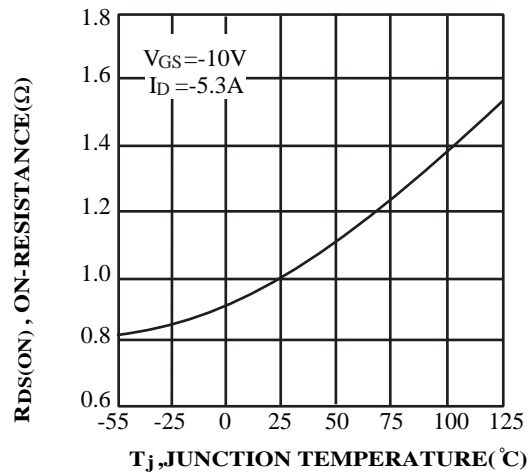
**FIG.1. Output Characteristics**



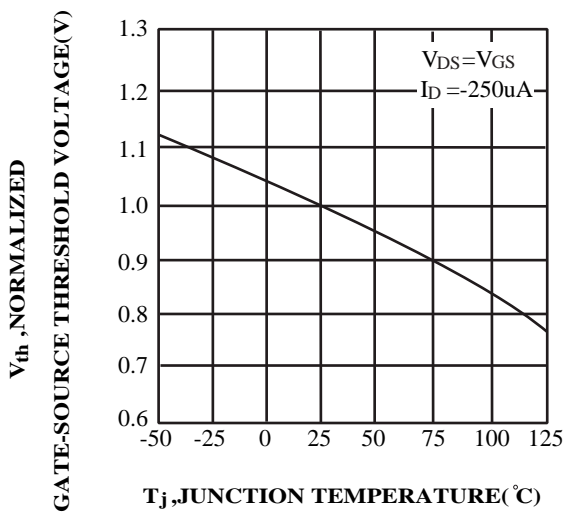
**FIG.2 Transfer Characteristics**



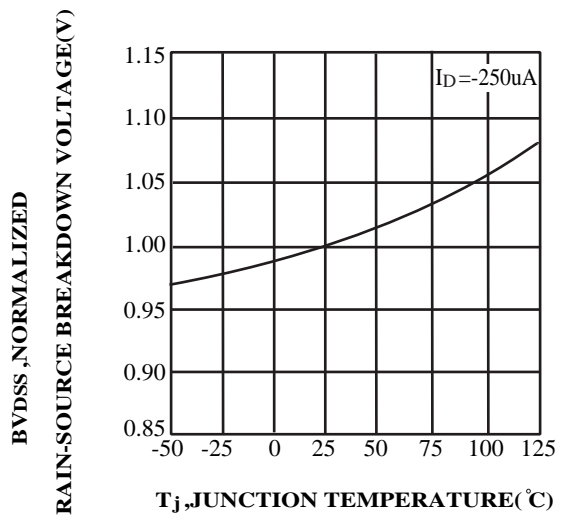
**FIG.3 Capacitance**



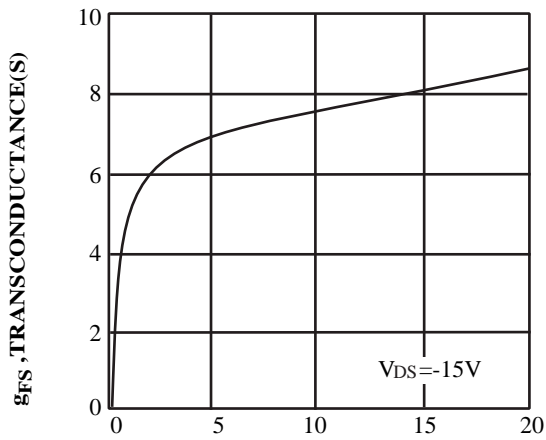
**FIG.4 On-Resistance Variation with Drain Current and Temperature**



**FIG.5 Gate Threshold Variation with Temperature**

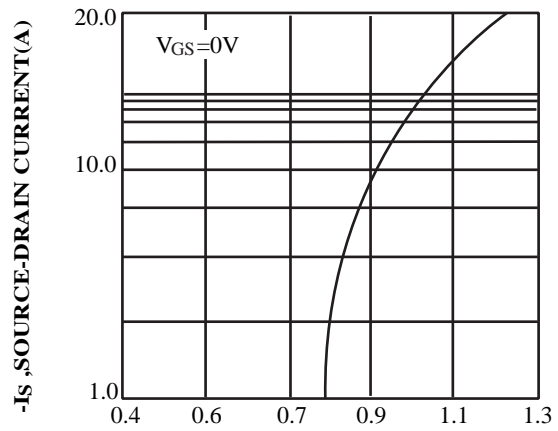


**FIG.6 Breakdown Voltage Variation with Temperature**



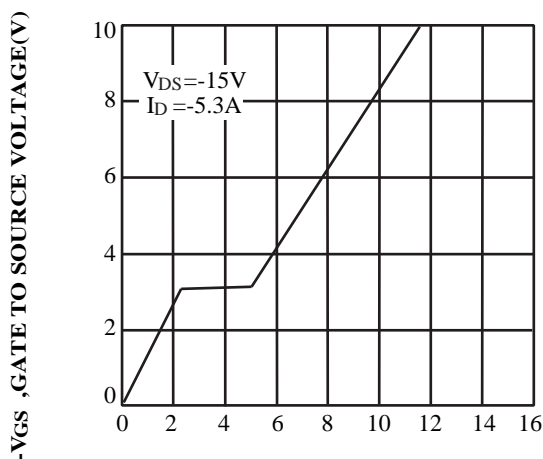
$-I_{DS}$  ,DRAIN-SOURCE CURRENT(A)

**FIG.7 Transconductance Variation with Drain Current**



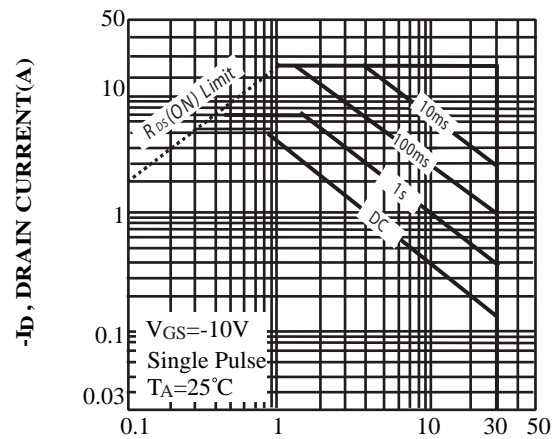
$V_{SD}$  ,BODY DIODE FORWARD VOLTAGE(V)

**FIG.8 Body Diode Forward Voltage Variation with Source Current**



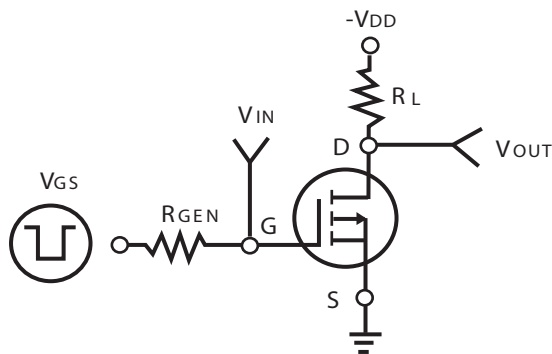
$Q_g$  ,TOTAL GATE CHARGE(nC)

**FIG.9 Gate Charge**

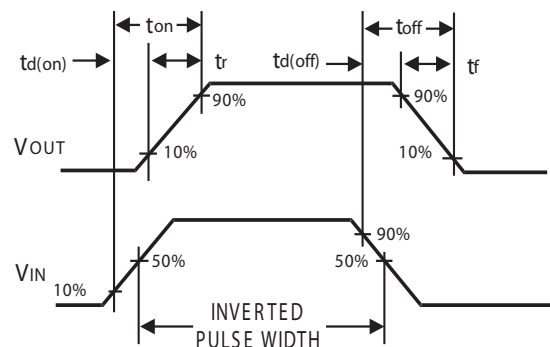


$-V_{DS}$  ,DRAIN-SOURCE VOLTAGE(V)

**FIG.10 Maximum Safe Operating Area**



**FIG.11 Switching Test Circuit**



**FIG.12 Switching Waveforms**

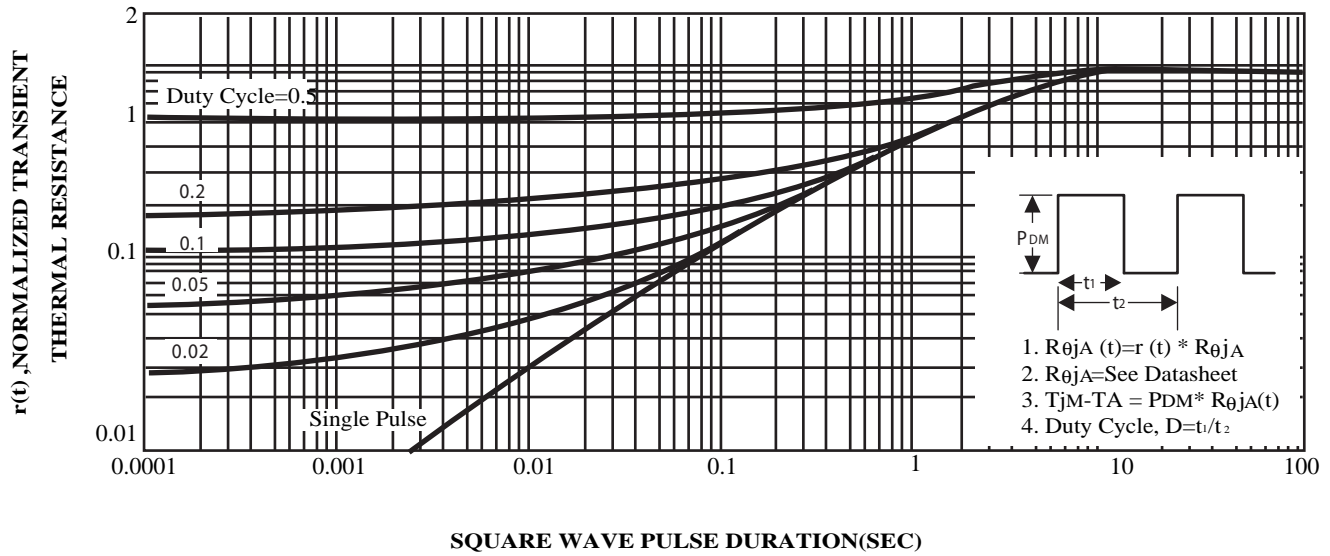
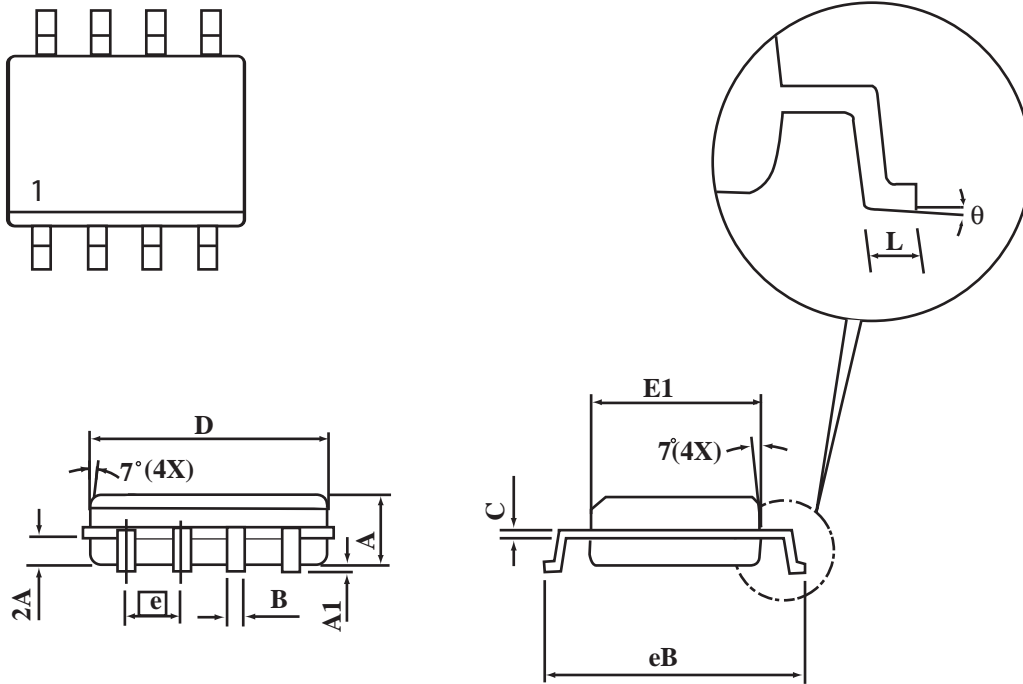


FIG.13 NORMALIZED THERMAL TRANSIENT IMPEDANCE CUREVE

SO-8 Package Outline Dimensions

Unit:mm



SYMBOLS	MILLIMETERS	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.20
B	0.35	0.45
C	0.18	0.23
D	4.69	4.98
E1	3.56	4.06
eB	5.70	6.30
e	1.27 BSC	
L	0.60	0.80
θ	0°	8°